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BINGHAM MCCUTCHEN LLP

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Robert Bartola, et al

Serial No.: 09/847,746

Filed: May 1, 2001

For: INTEGRATED COOLING OF A
PRINTED CIRCUIT BOARD
STRUCTURE

) Group Art Unit: 2835

) Confirmation No.: 6090

) Examiner: Michael Datskovsky

AMENDMENT AFTER ALLOWANCE UNDER 1.312

Commissioner for Patents
Washington, D.C. 20231

Attn: Michael Datskovsky

Dear Sir:

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DEC 17 2002

TECHNOLOGY CENTER 2800

Pursuant to 37 C.F.R. §1.312, please amend the application as follows:

In the Specification:

↓
Please insert paragraphs [0022.1] at page 8, and [0033.1] at page 12, to
read:

B1
[0022.1] FIG. 8 is a cross-section of a portion of a cooling channel in an
alternate PCB embodiment, in which a transistor die attached to the PCB mounting
area comprises a surface forming a portion of a cooling channel.

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